L Number	Hits	Search Text	DB	Time stamp
1	18	(("5850690") or ("6667192") or ("6425526")	USPAT;	2004/04/04 13:53
		or ("6448638") or ("6446874") or	US-PGPUB;	
		("6132799") or ("6468835") or ("5671525")	EPO; JPO;	
		or ("5598032")).PN.	DERWENT;	
		5050600 11771	IBM_TDB	2004/04/04 13:18
2 3	7	5850690.URPN. (micro\$1module or module) same (metal\$9	USPAT;	2004/04/04 13:18
3	_	near10 grid) same film same deform\$3	US-PGPUB;	2004/04/04 14.10
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
4	96		USPAT;	2004/04/04 13:56
		near10 grid) and film and deform\$3	US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
5	44	((micro\$1module or module) and (metal\$9	USPAT;	2004/04/04 14:12
		near10 grid) and film and deform\$3) and	US-PGPUB;	
ļ		(cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet) and (reel or line)	DERWENT; IBM TDB	
6	44		USPAT;	2004/04/04 14:07
1	.,	near10 grid) and film and deform\$3) and	US-PGPUB;	
1		(cu or copper or ni or nickel or au or	EPO; JPO;	
]		gold) and (printing or offset or inkjet)	DERWENT;	
		and (reel or line)) and deposit\$3	IBM_TDB	0004/04/04 14 00
7	3	((((micro\$1module or module) and (metal\$9 near10 grid) and film and deform\$3) and	USPAT; US-PGPUB;	2004/04/04 14:08
1		(cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet)	DERWENT;	
		and (reel or line)) and deposit\$3) and	IBM_TDB	
		card		
8	50	(micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:28
		same (metal\$9 near10 grid) same (card or medi\$2)	US-PGPUB; EPO; JPO;	
		medi42/	DERWENT;	
			IBM_TDB	
9	7	((micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:29
		same (metal\$9 near10 grid) same (card or	US-PGPUB;	
		medi\$2)) and (cu or copper or ni or nickel or au or gold) and (printing or offset or	EPO; JPO; DERWENT;	
		inkjet) and (reel or line)	IBM TDB	
12	4	1	USPAT;	2004/04/04 14:15
		same (metal\$9 near10 grid) same (card or	US-PGPUB;	
		medi\$2)) and (cu or copper or ni or nickel	EPO; JPO;	
		or au or gold) and (printing or offset or inkjet or tracing) and (reel or line)) and	DERWENT; IBM TDB	
		deposit\$3		
10	7	((micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:25
		same (metal\$9 near10 grid) same (card or	US-PGPUB;	
1		medi\$2)) and (cu or copper or ni or nickel or au or gold) and (printing or offset or	EPO; JPO; DERWENT;	
		inkjet or tracing) and (reel or line)	IBM TDB	
13	129530	(micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:28
		same (card or medium)	US-PGPUB;	
1			EPO; JPO;	
1			DERWENT;	
14	84841	(micro\$1module or module or ic or chip)	IBM_TDB USPAT;	2004/04/04 14:28
	04041	same card	US-PGPUB;	2004/04/04 14.20
			EPO; JPO;	
			DERWENT;	
1.5	120	//mi-ama@1madis1a_am_madis1a_am_da_amadis	IBM_TDB	2004/04/04 14 55
15	170	((micro\$1module or module or ic or chip) same card) and (metal\$9 near30 grid)	USPAT; US-PGPUB;	2004/04/04 14:29
		same card , and (metaly) hearst grid)	EPO; JPO;	
			DERWENT;	
			IBM TDB	

Page 1

16	41	(((micro\$1module or module or ic or chip)	USPAT;	2004/04/04 14:29
10	41	same card) and (metal\$9 near30 grid))	US-PGPUB;	=====================================
		and (cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet)	DERWENT;	
			IBM TDB	
18	37	((((micro\$1module or module or ic or chip)	USPAT;	2004/04/04 15:17
		same card) and (metal\$9 near30 grid))	US-PGPUB;	
		and (cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet))	DERWENT;	
		and deposit\$3	IBM_TDB	
17	15	• • • • • • • • • • • • • • • • • • •	USPAT;	2004/04/04 15:16
		same card) and (metal\$9 near30 grid))	US-PGPUB;	
		and (cu or copper or ni or nickel or au or	EPO; JPO;	
		gold) and (printing or offset or inkjet))	DERWENT;	
10	2212	and deform\$5 235/492.ccls.	IBM_TDB USPAT;	2004/04/04 16:35
19	2212	235/492.0015.	US-PGPUB;	2004/04/04 16:33
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
20	23	(((((micro\$1module or module or ic or	USPAT;	2004/04/04 15:17
		chip) same card) and (metal\$9 near30	US-PGPUB;	
		grid)) and (cu or copper or ni or nickel	EPO; JPO;	
		or au or gold) and (printing or offset or	DERWENT;	
		inkjet)) and deposit\$3) not	IBM_TDB	
		((((micro\$1module or module or ic or		
		chip) same card) and (metal\$9 near30		
		grid)) and (cu or copper or ni or nickel		
		or au or gold) and (printing or offset or inkjet)) and deform\$5)		
21	27		USPAT;	2004/04/04 15:23
- 1	2'	chip or module)	US-PGPUB;	2001/01/01 15.25
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
22	9	(USPĀT;	2004/04/04 16:02
		or ("5057679")).PN.	US-PGPUB;	
		·	EPO; JPO;	
			DERWENT;	
24	1.	5057670 UDDN	IBM_TDB	0004/04/04 16 16
24 25	471	5057679.URPN. 235/488.ccls.	USPAT	2004/04/04 16:16
23	4/1	23J/400.CCIS. 	USPAT; US-PGPUB;	2004/04/04 16:35
			EPO; JPO;	
			DERWENT;	
			IBM TDB	